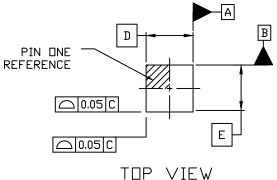
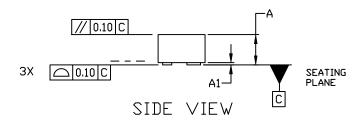
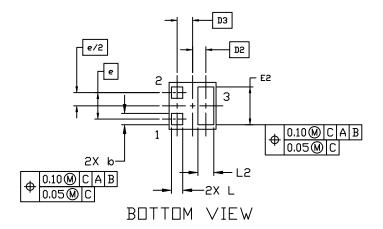
## XLLGA3, 0.62x0.62, 0.35P CASE 713AA ISSUE D

**DATE 12 MAR 2021** 





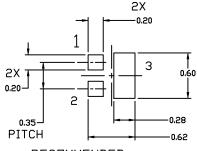




## NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2. CONTROLLING DIMENSION: MILLIMETERS

	MILLIMETERS			
DIM	MIN.	N□M.	MAX.	
Α	0.34	0.39	0.43	
A1	0.000		0.03	
b	0.10	0.15	0.20	
D	0.57	0.62	0.67	
D2	0.175 BSC			
DЗ	0.205 BSC			
E	0.57	0.62	0.67	
E2	0.40	0.50	0.60	
е	0.350 BSC			
k	0.200 REF			
L	0.09	0.15	0.21	
L2	0.11	0.21	0.31	



## RECOMMENDED MOUNTING FOOTPRINT

For additional information on our Pb-Free strategy and soldering details, please download the IIN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

## GENERIC MARKING DIAGRAM\*



X = Specific Device CodeM = Date Code

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION:	XLLGA3, 0.62x0.62, 0.35P		PAGE 1 OF 1

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